

#	Layer	Thickness	Description	Dk	Df
	Top Solder	0.015mm	Soldermask IPC-SM840	3,5	0,028
1	Top Side	0.045mm	ED Copper + plating		
		0.125mm	Prepreg IPC-4101/21	3,5	0,02
2	Inner Layer 1	0.035mm	ED Base Copper		
		0.410mm	Core IPC-4101/21	4,3	0,02
3	Inner Layer 2	0.035mm	ED Base Copper		
		0.125mm	Prepreg IPC-4101/21	3,5	0,02
4	Inner Layer 3	0.035mm	ED Base Copper		
		0.410mm	Core IPC-4101/21	4,3	0,02
5	Inner Layer 4	0.035mm	ED Base Copper		
		0.125mm	Prepreg IPC-4101/21	3,5	0,02
6	Inner Layer 5	0.035mm	ED Base Copper		
		0.410mm	Core IPC-4101/21	4,3	0,02
7	Inner Layer 6	0.035mm	ED Base Copper		
		0.125mm	Prepreg IPC-4101/21	3,5	0,02
8	Bottom Side	0.045mm	ED Copper + plating		
	Bottom Solder	0.015mm	Soldermask IPC-SM840	3,5	0,028

Total thickness: 2.060mm

notes: Final copper thickness according to IPC-6012 Please regard to our sectional design rules: ► www.we-online.com	BASIC8_ML8_2,06_35		
	PCB Thickness Tolerance: ± 10%		
	customer		created
	pcb name		approved
	engineer		format
	date		A4, landscape
Template Revision: 07/2020 by Andreas Schilpp / Michael Kress / Werner Öchslen			

